LITEON LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only

\mathbf{LED}	DI	SPI	$[\ . oldsymbol{\Delta}]$	${f V}$

LTS-4817SW-P DATA SHEET

<u>ITEM</u>	<u>Description</u>	By	DATE
1	New Spec	Reo Lin	2011/08/24
2	2.1 Modify packing dimensions.2.2 Modify recommended soldering condition patterns.	Reo Lin	2011/09/21

PAGE: 0 of 12 PART NO.:LTS-4817SW-P

LITEON

LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only

FEATURES

- *0.39 inch (10.0 mm) DIGIT HEIGHT
- *CONTINUOUS UNIFORM SEGMENTS
- ***LOW POWER REQUIREMENT**
- *EXCELLENT CHARACTERS APPEARANCE
- *HIGH BRIGHTNESS & HIGH CONTRAST
- *WIDE VIEWING ANGLE
- *** SOLID STATE RELIABILITY**
- *CATEGORIZED FOR LUMINOUS INTENSITY
- *SMD DISPLAY
- *LEAD FREE PACKAGE (ACCORDING TO ROHS)

DESCRIPTION

The LTS-4817SW-P is a 0.39 inch (10.0 mm) digit height single digit SMD display. This device uses LTW-C193 series InGaN white Chip LED. The display has gray face and white segments, and suitable for reverse mount assembly.

DEVICE

PART NO.	DESCRIPTION
InGaN White	C
LTS-4817SW-P	Common Anode

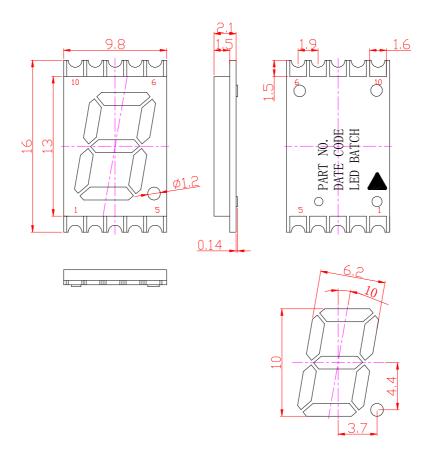
PART NO.:LTS-4817SW-P PAGE: 1 of 12

LITEON

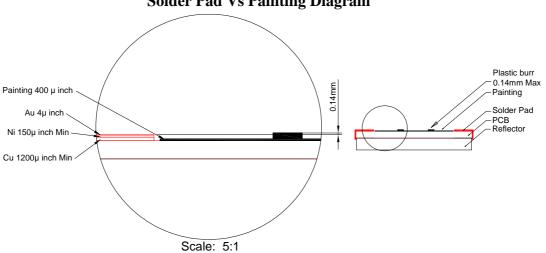
LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only

PACKAGE DIMENSIONS



Solder Pad Vs Painting Diagram

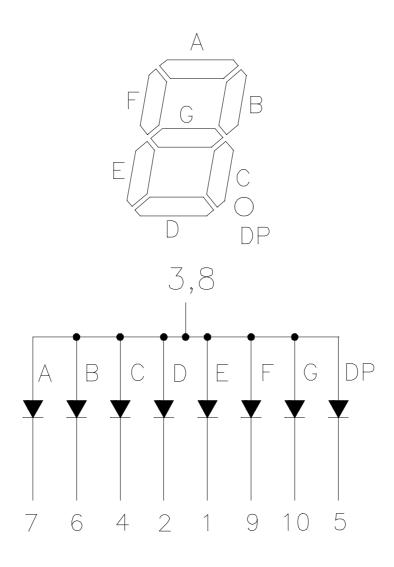


NOTES:

- 1. Plastic pins' burr max. 0.14 mm,
- 2. All dimensions are in millimeters. Tolerances are \pm 0.25mm (0.01") unless otherwise noted.
- 3. Solder pad materials and thickness: Cu: 1200μ inch Ni: Min 150μ inch Au: 4μ inch.

PART NO.:LTS-4817SW-P PAGE: 2 of 12

INTERNAL CIRCUIT DIAGRAM



PART NO.:LTS-4817SW-P PAGE: 3 of 12

LITEON LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only

PIN CONNECTION

No.	CONNECTION
1	CATHODE E
2	CATHODE D
3	COMMON ANODE
4	CATHODE C
5	CATHODE D.P.
6	CATHODE B
7	CATHODE A
8	COMMON ANODE
9	CATHODE F
10	CATHODE G

PAGE: 4 of 12 PART NO.:LTS-4817SW-P



Property of Lite-On Only

CHIP LED ABSOLUTE MAXIMUM RATING AT Ta = 25°C

PARAMETER	MAXIMUM RATING	UNIT			
Power Dissipation Per Segment	70	mW			
Peak Forward Current Per Segment	100	mA			
(Frequency 1Khz,10% duty cycle)	100				
Continuous Forward Current Per Segment	20	mA			
Forward Current Derating from 25 °C	0.25	mA/°C			
Operating Temperature Range -35 °C to +80 °C					
Storage Temperature Range -55 °C to +105 °C					
Iron Soldering Conditions: 1/16 inch Below Seating Plane for 3 Seconds at 260 °C					

CHIP LED ELECTRICAL / OPTICAL CHARACTERISTICS AT Ta = 25°C

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION
Luminous Intensity	IV	28.0	44.0		mcd	IF = 5mA
Luminous Intensity	1 V					Note 1, 2, 5
Chromaticity Coordinates	X		0.294			IF = 5mA
	y		0.286			Note 3, 5
Forward Voltage Per Segment	$V_{\rm F}$	2.70		3.2	V	IF = 5mA
Barraga Cramont Ban Sagmant	т			100	,, A	V _R =5V
Reverse Current Per Segment	\mathbf{I}_{R}			100	$\mu \mathbf{A}$	Note 7

Note:

- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE (Commission Internationale De L'Eclairage) eye-response curve.
- 2. Iv classification code is marked on each packing bag.
- 3. The chromaticity coordinates (x, y) is derived from the 1931 CIE chromaticity diagram.
- 4. Caution in ESD:

Static Electricity and surge damages the LED. It is recommend using a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

- 5. Tester: CAS140B is for the chromaticity coordinates (x, y) and IV.
- 6. The chromaticity coordinates (x, y) guarantee should be added ± 0.01 tolerance.
- 7. Reverse voltage is only for IR test. It can not continue to operate at this situation.

PART NO.:LTS-4817SW-P	PAGE:	5 of 12
-----------------------	-------	---------



Property of Lite-On Only

Chip LED Bin Code List

V _F Spec. Table					
V _F Bin	Forward Voltage (V) at I _F =5mA				
V _F DIII	Min.	Max			
3	2.7	2.8			
4	2.8	2.9			
5	2.9	3.0			
6	3.0	3.1			
7	3.1	3.2			

Tolerance on each Forward Voltage bin is +/-0.1 volt

	Iv Spec. Table				
Iv Bin	Iv (mcd) at $I_F=5mA$				
IV Dill	Min.	Max.			
Q11	71.0	81.0			
Q12	81.0	90.0			
Q21	90.0	101.0			
Q22	101.0	112.0			
R11	112.0	129.0			
R12	129.0	146.0			
R21	146.0	165.0			

Tolerance on each Luminous Intensity bin is +/-10%

Color Ranks Table						
Ranks		Colo	or bin limits	at $I_F = 5mA$		
Kaliks		CIE 193	1 Chromati	city coordina	ates	
S1-2	X	0.284	0.284	0.294	0.294	
31-2	у	0.240	0.272	0.286	0.254	
S2-2	X	0.284	0.284	0.294	0.294	
32-2	у	0.272	0.305	0.319	0.286	
S3-1	X	0.294	0.294	0.304	0.304	
	у	0.254	0.286	0.300	0.268	

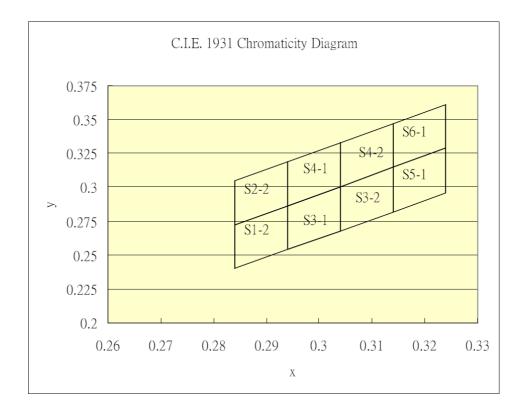
PART NO.:LTS-4817SW-P PAGE: 6 of 12



Property of Lite-On Only

S3-2	X	0.304	0.304	0.314	0.314
33-2	у	0.268	0.300	0.315	0.282
S4-1	X	0.294	0.294	0.304	0.304
54-1	у	0.286	0.319	0.333	0.300
S4-2	X	0.304	0.304	0.314	0.314
S4- 2	у	0.300	0.333	0.347	0.315
S5-1	X	0.314	0.314	0.324	0.324
33-1	у	0.282	0.315	0.329	0.296
S6-1	X	0.314	0.314	0.324	0.324
	y	0.315	0.347	0.361	0.329

Tolerance on each Hue (x,y) bin is ± -0.01



PART NO.:LTS-4817SW-P PAGE: 7 of 12

TYPICAL ELECTRICAL / OPTICAL CHARACTERISTIC CURVES

(25°C Ambient Temperature Unless Otherwise Noted)

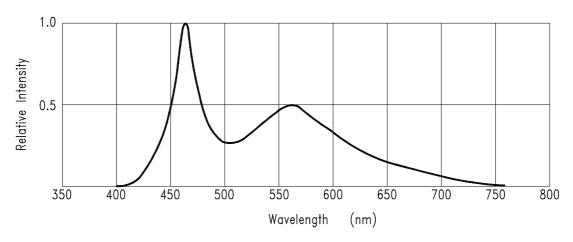
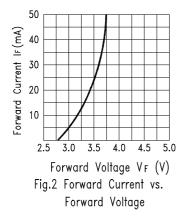
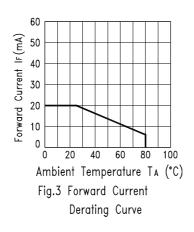


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH





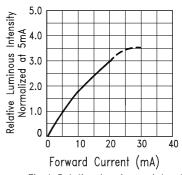


Fig.4 Relative Luminous Intensity
vs. Forward Current

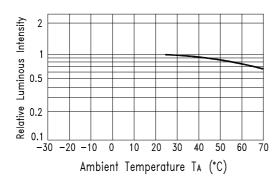


Fig.5 Luminous Intensity vs.

Ambient Temperature

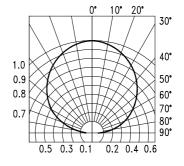


Fig.6 Spatial Distribution

PART NO.:LTS-4817SW-P

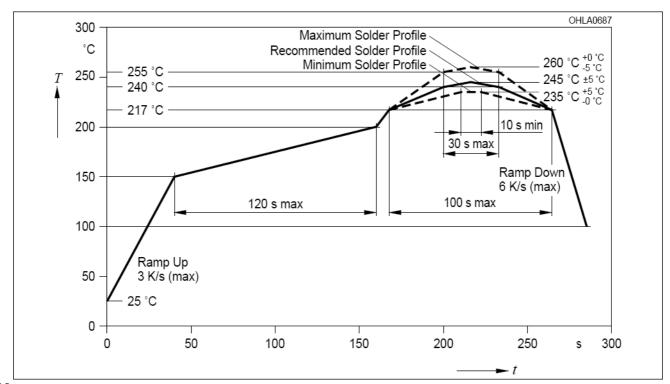
PAGE:

8 of 12



Property of Lite-On Only

SMT SOLDERING INSTRUCTION



Note:

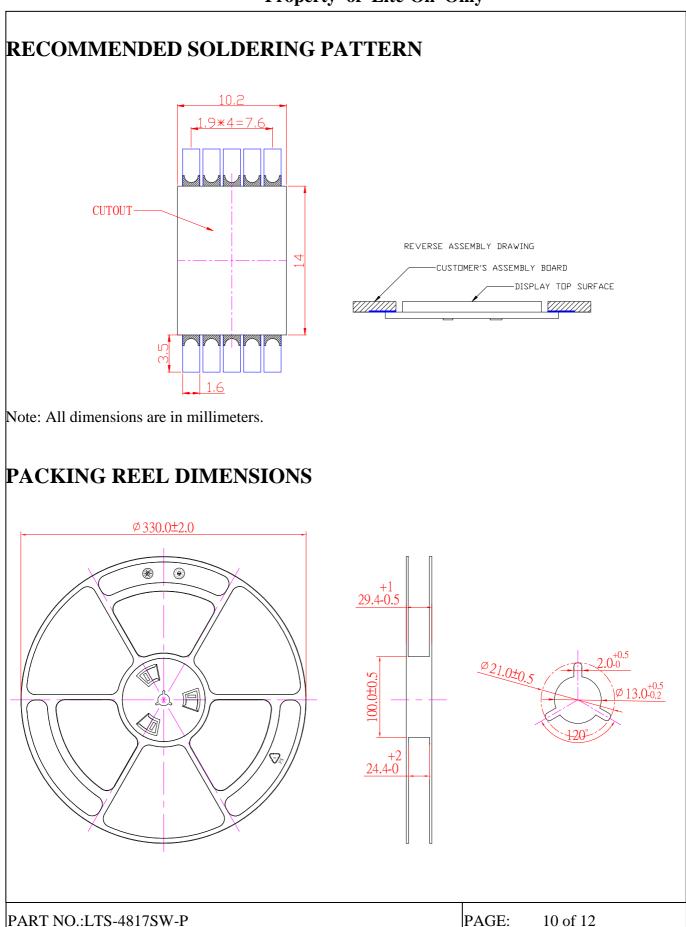
1. Recommended soldering condition:

Reflow Soldering (T	wo times only)	Soldering Iron (One time only)		
Pre-heat:	120~150°C.	Temperature	300°C Max.	
Pre-heat time:	120sec. Max.	Soldering time	3sec. Max.	
Peak temperature:	260°C Max.			
Soldering time:	5sec. Max.			

2. Number of reflow process shall be less than 2 times, and cooling process to normal temperature is required between the first and the second soldering process.

PART NO.:LTS-4817SW-P PAGE: 9 of 12

Property of Lite-On Only



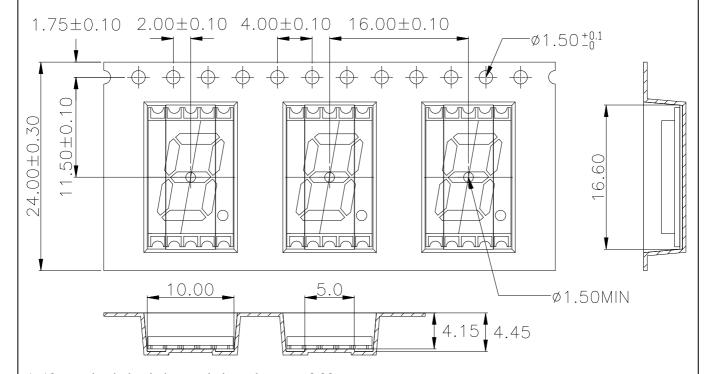
LITEON

LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only

PACKING CARRIER DIMENSIONS

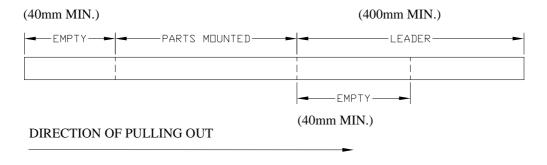
1. Taping parts:



- 1. 10 sprocket hole pitch cumulative tolerance ±0.20.
 2. Carrier camber is within 1 mm in 250 mm.
 3. All dimensions meet EIA-481-C requirements.

- 4. Thickness: 0.40±0.05mm.
- 5. Packing length per 22" reel : 45.50 Meters. 6. Component load per 13" reel : 800 pcs.

2. Trailer part/ Leader part:



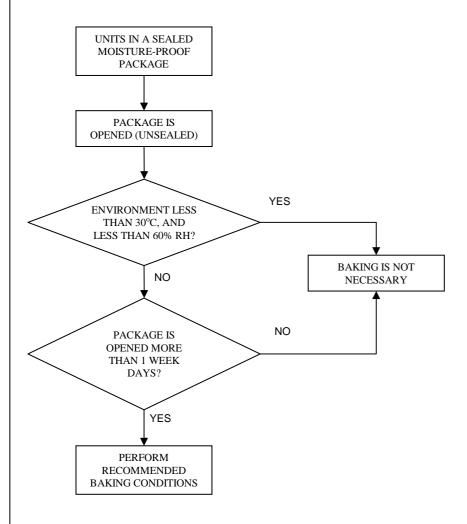
PART NO.:LTS-4817SW-P PAGE: 11 of 12



Property of Lite-On Only

Moisture Proof Packaging

All N/D SMD displays are shipped in moisture proof package. The displays should be stored at 30°C or less and 90% RH or less. Once the package opened, moisture absorption begins.



Baking Conditions

If the parts are not stored in dry conditions, they must be baked before reflow to prevent damage to the parts.

Package	Temperature	Time
In Reel	60°C	≥48hours
In Bulk	100°C	≧4hours
	125°C	≥2hours

Baking should only be done once.

PART NO.:LTS-4817SW-P PAGE: 12 of 12
